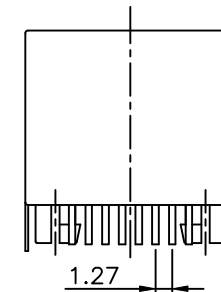
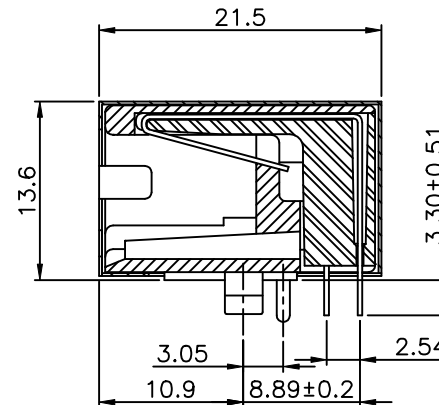
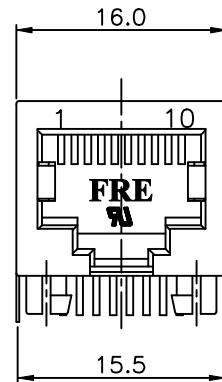


D1RFRD006

REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD



NOTES:

ELECTRICAL:

1. VOLTAGE RATING : 125 VAC RMS.
2. CURRENT RATING : 1.5 AMP.
3. CONTACT RESISTANCE : 40 MINIOHMS MAX.
4. INSULATION RESISTANCE: 1000 MEGOHMS MIN @ 500 VDC.
5. DIELECTRIC STRENGTH : 1000 VAC RMS 60Hz, 1MIN.

MECHANICAL:

1. HOUSING MATERIAL : NYLON+30%.G.F UL94V-0.  
2. CONTACT MATERIAL : PHOSPHOR BRONZE t=0.35mm.  
3. PLATING : 1: CONTACT AREA- SELECTIVE GOLD PLATING.  
2: TAILS PLATE TIN OVER NICKEL.  
4. OPERATING LIFE : 750 CYCLES MIN.  
5. PCB RETENTION PRE-SOLDER : 1 LB MIN.  
6. PCB RETENTION POST-SOLDER: 10 LBS MIN.

ENVIRONMENTAL:

1. STORAGE : -40°C TO +85°C.
2. OPERATION: 0°C TO 70°C.
3. WAVE SOLDERING TEMPERATURE: 255~265°C (5~10 SECONDS)

UNITED STATES DEPARTMENT OF COMMERCE  
NATIONAL BUREAU OF STANDARDS  
FEDERAL COMMUNICATIONS COMMISSION  
FCC PART 68, SUBPART F.

CUL FILE NO. E163191

ROHS PART NUMBER: E590X-1X075X-L

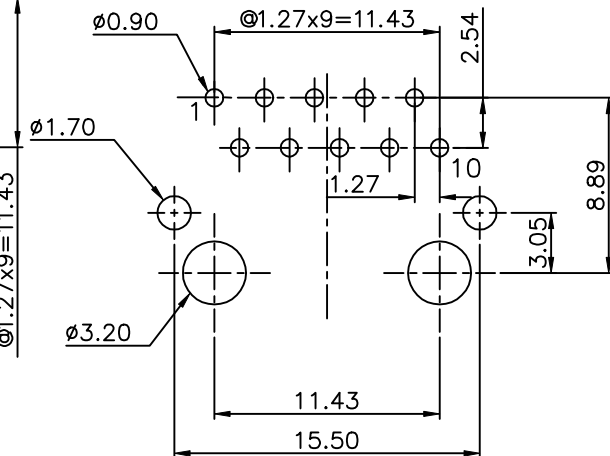
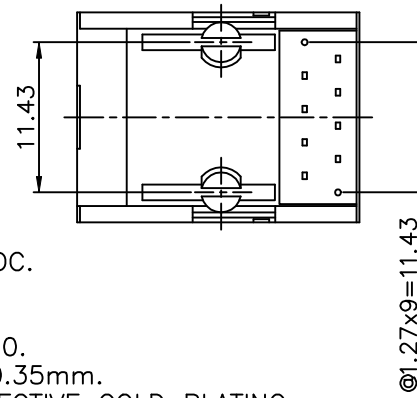
NO. OF CONTACT:

8- 8C  
1- 10C

Shield: —  
3— Tin  
5— Nickel


- Gold Thickness

1- 3u"      2- 6u"  
3-15u"      4-30u"  
5-50u"



PC Board Layout Component Side Shown

OLD P/N: 5-0456-1

DETACHED LISTS	<div>MM (INCH)</div>		DFTO JAMY	DATE 7/12/05	FULL RISE ELECTRONIC CO., LTD		
	TOLERANCES EXCEPT AS NOTED		CHKDSAMMY	DATE 2005/07/15			
	MM .0 ± 0.2 .00 ± 0.15 .000 ± 0.075	±  ±  ±	MFO	DATE			
			APPVLLUSHENG	DATE 2005/07/15			
			MATERIAL :				
	ANGLES ±		QT*Y :	TITLE  20.57 PCB JACK 10P			
			FINISH :				
	THIRD ANGLE PROJECTION		SCALE : 2.5:1	DRAWING NO. GE593263-LA		SIZE A3	REV 7/12/05 0
				/PART NO. SEE NOTE			
	DO NOT SCALE DRAWING			SHEET		OF	

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